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In-situ Cryogenic Single-Event Effects Testing of High-Speed SiGe BiCMOS Devices

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Motivation

- Primary considerations for systems targeted at long term operation in distant, extreme environments
 - Weight
 - Power consumption
 - Tolerance of extreme temperatures AND radiation
- Application of advanced technologies
 - Design techniques can address wide temperature range operation
 - RHBD techniques can address radiation
 - Reduce requirements for environmental controls
- Need to characterize response - cryo + radiation
 - Very low temperatures
 - Little data available for rad effects at low temp; existing data indicates reduced temperature may exacerbate SE effects
 - Define worst case for designers
 - Validate models and hardware designs with test data

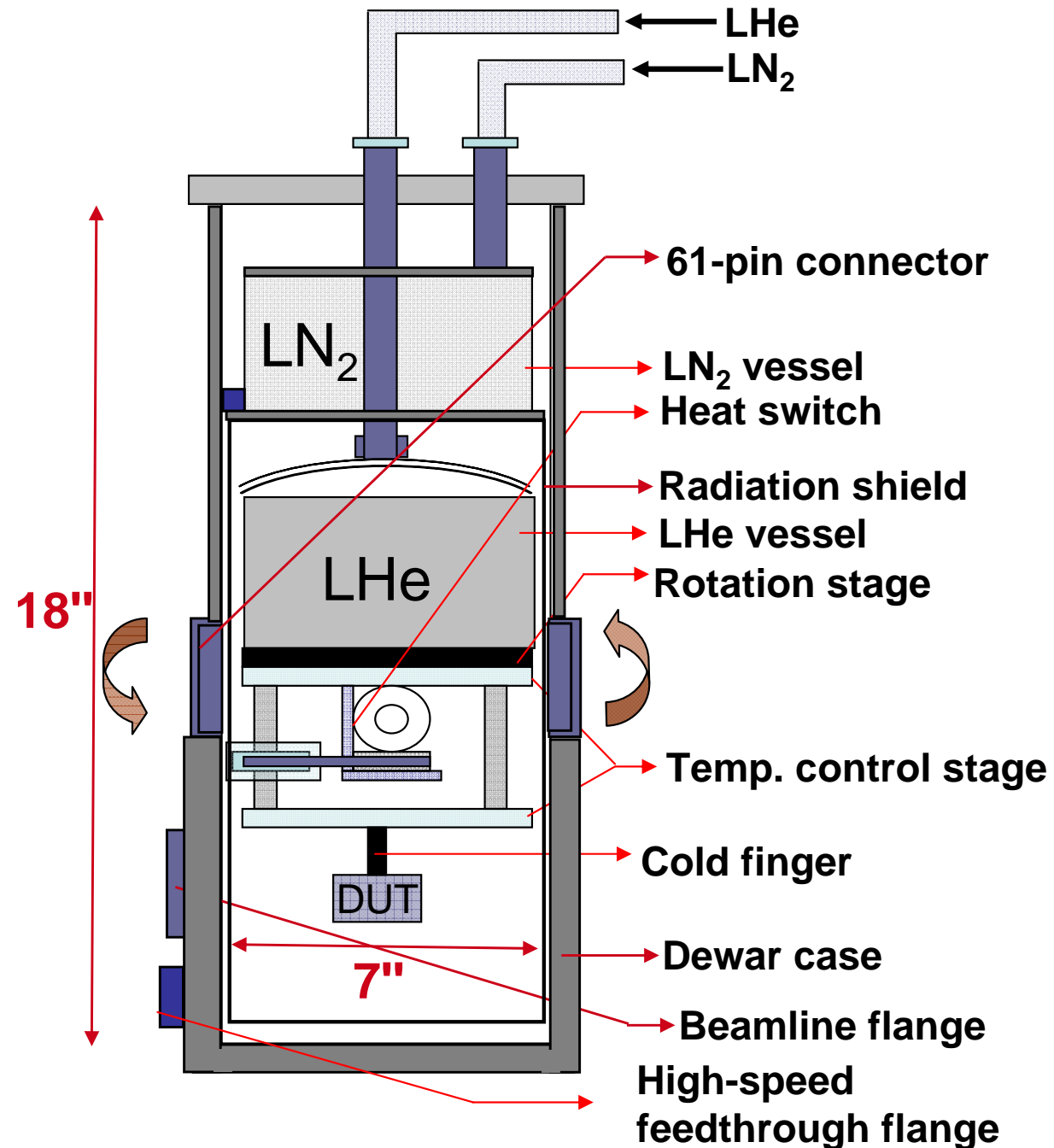
Approach

- Establish a new test system to measure single-event (SE) effects at cryogenic temperatures (cryo)
 - Portable
 - Compatible with multiple test facilities
 - Suitable for multiple technologies and operating speeds
- Apply test system to characterize the response of SiGe BiCMOS devices and circuits
 - Generate heavy-ion experimental data at cryo to aid future NASA missions
 - Basic device level testing to provide models to use in designs
 - Circuit testing to validate designs

A Unique Dewar

IPPW-6: Extreme Environments

- Dual (LHe & LN₂) use Dewar
- Easily portable; weighs about 20 lbs
- Beam facility “flange-adaptable”
- Device under test (DUT) can be rotated about a vertical axis *in-situ* and under vacuum
- Heat switch provided for controlling DUT temperature
- Test-circuit-adaptable “cold-finger”



A Closer Look..

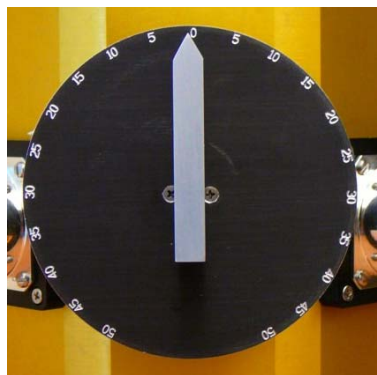
IPPW-6: Extreme Environments



Temperature controller



61-pin connector
(1 of 4)



Rotation stage
control knob

Blank ports (1 of 2, for
high-speed feedthroughs)

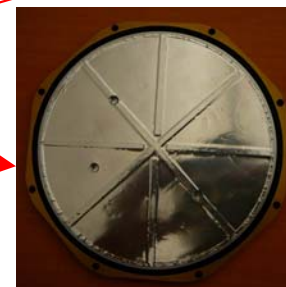
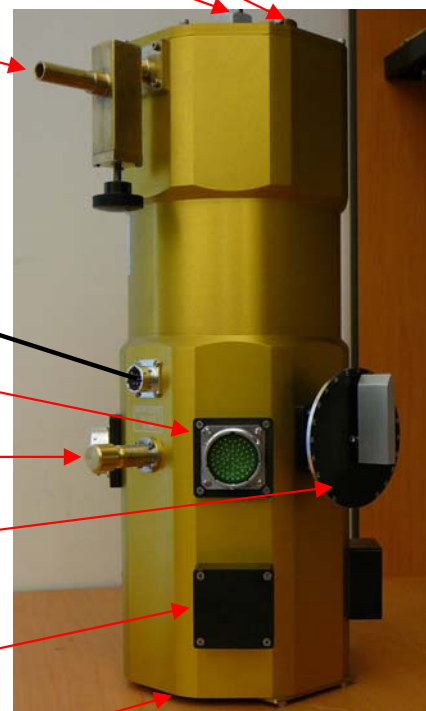
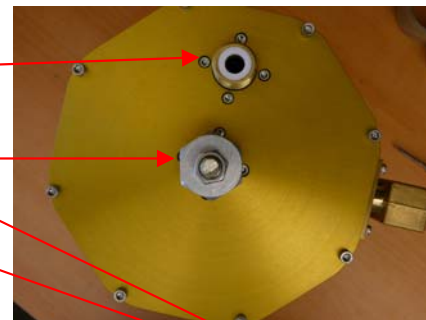
Cover plate +
radiation shield

LN₂ fill port

LHe fill port

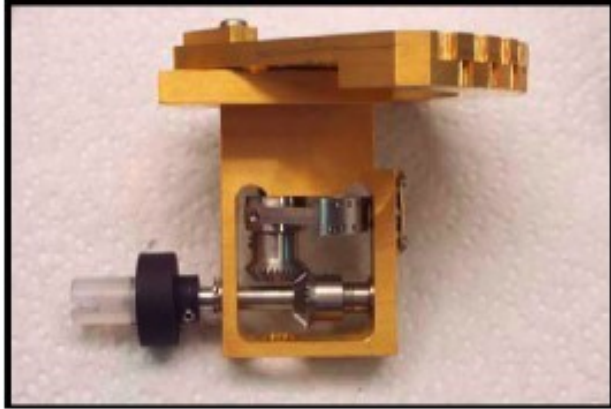
Vacuum port

Heat switch control knob



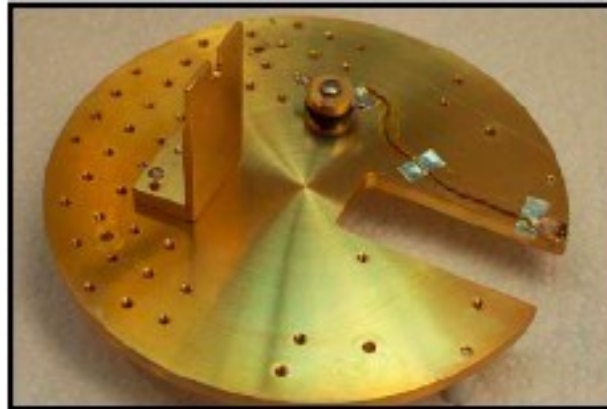
Key Dewar Modules

IPPW-6: Extreme Environments



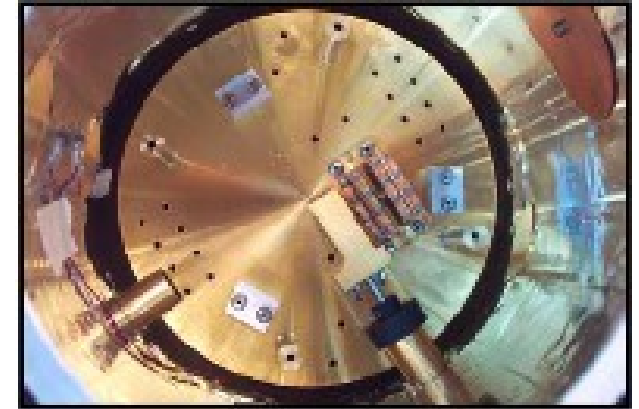
Rotation stage assembly

- Rotation in 5° increments, about a vertical axis
- A total rotation span of 68°



Cold plate + heater

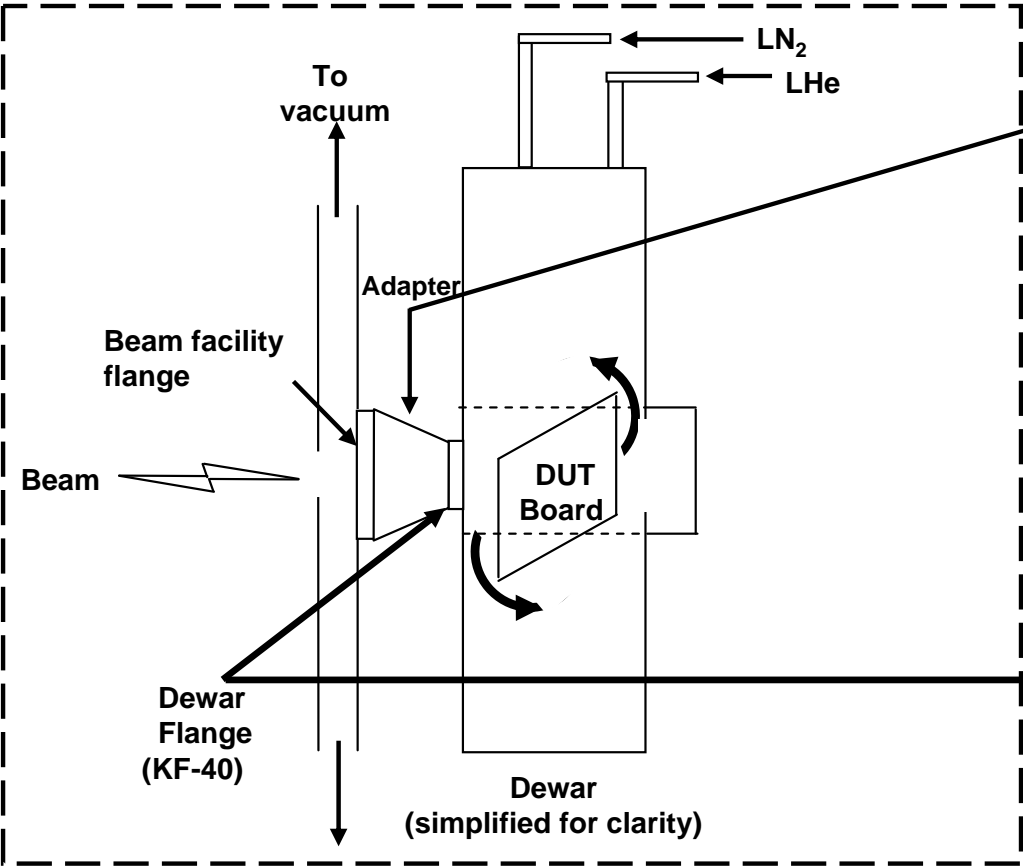
- Dewar cold plate would be at or very close to cryogen temperature
- Power output to heater to be controlled by temperature controller



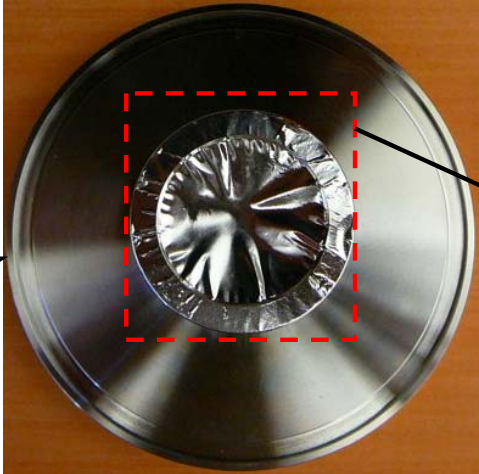
Cold plate + heat switch

- Position of heat switch determines the amount of heat delivered
- 25 turns on the control knob represent 0 through 100% heat delivered

Dewar Flange & Adaptations



Dewar mounting at beam facility



KF-40 adaptation

Adapter flange for beam facility

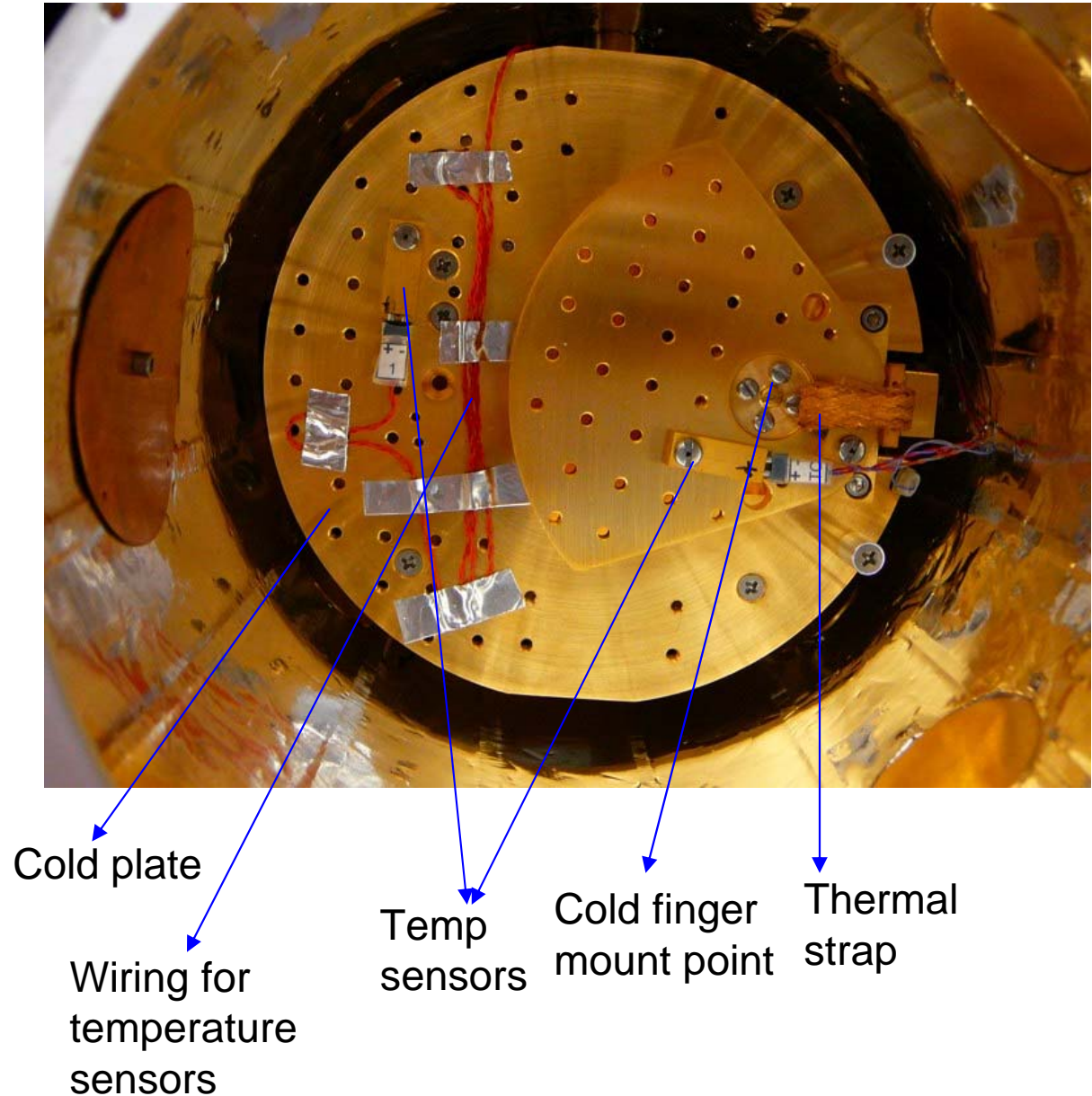


KF-40 flange (blacked out)

Dewar Rotation Stage

IPPW-6: Extreme Environments

- Mounted on to the Dewar cold plate
- Thermal strap used for temperature transfer b/w cold plate & rotation stage
- Capable of rotating 34° on either side about vertical axis
- Equipped with detachable temperature sensor
- Cold finger to be mounted on to the central axis of rotation stage

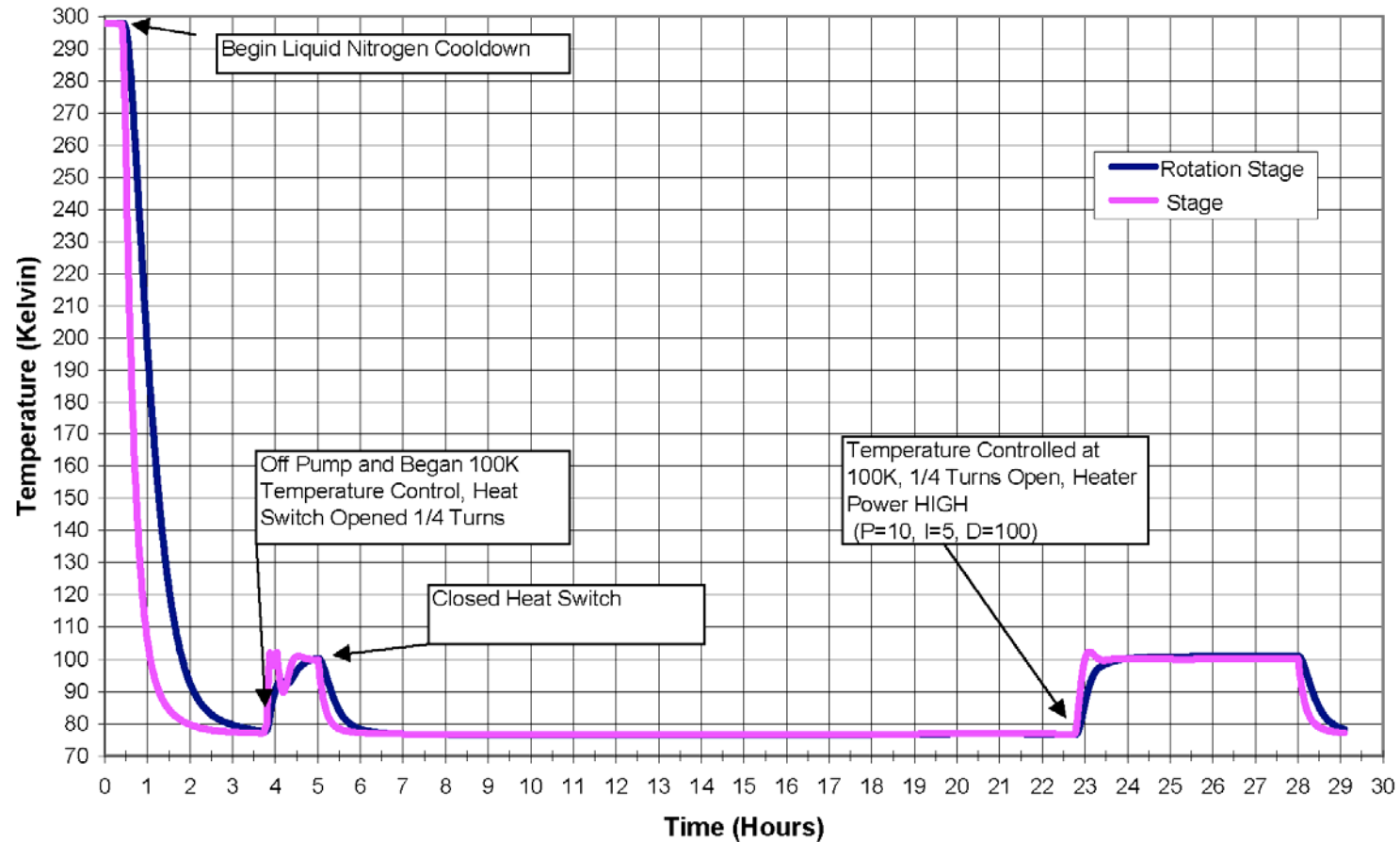


- “Dewar pre-qual” in process
 - Vacuum testing
 - Mechanical tests
 - Heating tests
 - Wiring tests
 - Electrical feed-through tests
- Exploring thermal imaging
 - Aid in mapping DUT heat profiles
 - Routing the wiring to mitigate “hot spots”
- Test devices and circuits designed and fabricated (or currently in fab)

Preliminary Dewar Tests

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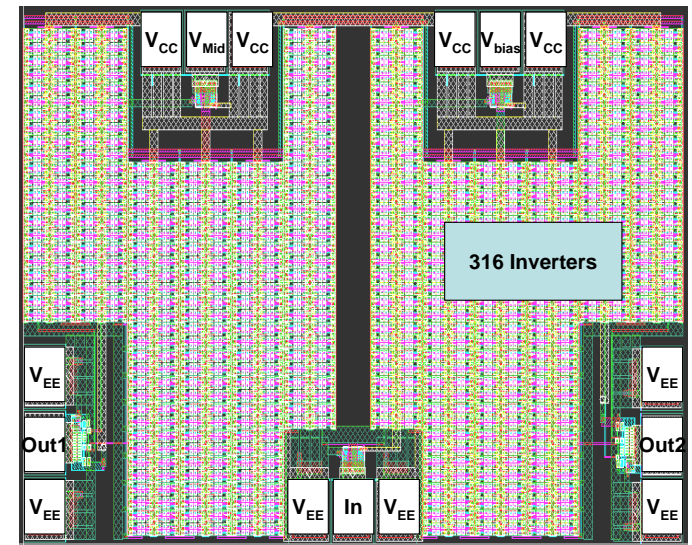
- Tests conducted at IR Labs
- “Loaded” through heat switch
- Lag seen due to thermal strap
- Mounting sensor close to DUT would avoid further lag



Hold-time tests for the Dewar's temperature and rotation stages

Plan

- Dry-run (no beam) at test facility (Texas A&M)
- First beam tests using string of 316 inverters
 - Design of cold finger for inverter string test in process
 - CMOS and HBT versions of test circuit
 - Regular and RHBD variants
 - Quantify SE-induced pulse widths @ cryo
- Subsequent tests
 - SRAM
 - Mixed signal sub-circuit
 - Newly designed BiCMOS remote “health monitoring” unit
 - *Every experiment to have a custom-designed cold finger*



Challenges

- Wiring - optimized routing required
- # of connections
- High-speed tests
 - Matching impedances
 - “Lossless” + “flexible” cables
- “Cold-stationing” of DUT
 - Cold finger interface bonding
 - PCB design

Summary

- New system for *in-situ* SE testing at cryo designed and built
 - Portable
 - Compatible with multiple test facilities
 - Suitable for multiple technologies and operating speeds
- System characterization in process
- Tests planned to
 - Generate experimental data at cryo to aid future NASA missions
 - Provide models to use in designs
 - Validate circuit designs

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BAE SYSTEMS

